



RF Power LDMOS Transistor

High Ruggedness N-Channel Enhancement-Mode Lateral MOSFET

Designed for handheld two-way radio applications with frequencies from 136 to 941 MHz. The high gain, ruggedness and wideband performance of this device make it ideal for large-signal, common-source amplifier applications in handheld radio equipment.

Wideband Performance (In 440–520 MHz reference circuit, 7.5 Vdc, $T_A = 25^\circ\text{C}$, CW)

Frequency (MHz)	P_{in} (W)	G_{ps} (dB)	η_D (%)	P_{out} (W)
440–520 (1,2)	0.16	16.2	62.0	6.5

Narrowband Performance (7.5 Vdc, $T_A = 25^\circ\text{C}$, CW)

Frequency (MHz)	G_{ps} (B)	η_D (%)	P_{out} (W)
520 (3)	20.3	70.8	6.8

Load Mismatch/Ruggedness

Frequency (MHz)	Signal Type	VSWR	P_{in} (dBm)	Test Voltage	Result
520 (3)	CW	> 65:1 at all Phase Angles	21 (3 dB Overdrive)	10.8	No Device Degradation

1. Measured in 440–520 MHz broadband reference circuit (page 6).
2. The values shown are the minimum measured performance numbers across the indicated frequency range.
3. Measured in 520 MHz narrowband production test fixture (page 9).

Features

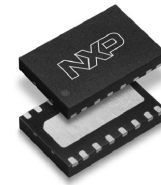
- Characterized for operation from 136 to 941 MHz
- Unmatched input and output allowing wide frequency range utilization
- Integrated ESD protection
- Integrated stability enhancements
- Wideband — full power across the band
- Exceptional thermal performance
- Extreme ruggedness
- High linearity for: TETRA, SSB

Typical Applications

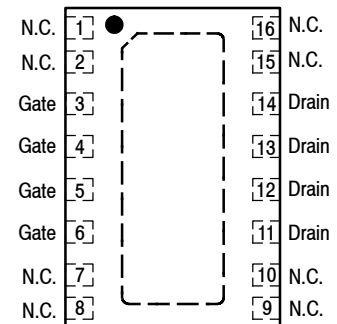
- Output stage VHF band handheld radio
- Output stage UHF band handheld radio
- Output stage for 700–800 MHz handheld radio
- Generic 6 W driver for ISM and broadcast final stage transistors

AFM906N

136–941 MHz, 6.0 W, 7.5 V
 WIDEBAND
 AIRFAST RF POWER LDMOS
 TRANSISTOR



DFN 4 × 6



(Top View)

Note: Exposed backside of the package is the source terminal for the transistor.

Figure 1. Pin Connections

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	-0.5, +30	Vdc
Gate-Source Voltage	V_{GS}	-6.0, +12	Vdc
Operating Voltage	V_{DD}	0 to 12.5	Vdc
Storage Temperature Range	T_{stg}	-65 to +150	°C
Case Operating Temperature Range	T_C	-40 to +150	°C
Operating Junction Temperature Range (1,2)	T_J	-40 to +150	°C
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	65.8 0.53	W W/°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value (2,3)	Unit
Thermal Resistance, Junction to Case Case Temperature 78°C, 6 W CW, 7.5 Vdc, $I_{DQ} = 100$ mA, 520 MHz	$R_{\theta JC}$	1.9	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22-A114)	1C, passes 1000 V
Machine Model (per EIA/JESD22-A115)	A, passes 50 V
Charge Device Model (per JESD22-C101)	IV, passes 2000 V

Table 4. Moisture Sensitivity Level

Test Methodology	Rating	Package Peak Temperature	Unit
Per JESD22-A113, IPC/JEDEC J-STD-020	3	260	°C

Table 5. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Off Characteristics					
Zero Gate Voltage Drain Leakage Current ($V_{DS} = 30$ Vdc, $V_{GS} = 0$ Vdc)	I_{DSS}	—	—	2	μAdc
Zero Gate Voltage Drain Leakage Current ($V_{DS} = 7.5$ Vdc, $V_{GS} = 0$ Vdc)	I_{DSS}	—	—	1	μAdc
Gate-Source Leakage Current ($V_{GS} = 5$ Vdc, $V_{DS} = 0$ Vdc)	I_{GSS}	—	—	500	nAdc
On Characteristics					
Gate Threshold Voltage ($V_{DS} = 10$ Vdc, $I_D = 78$ μAdc)	$V_{GS(th)}$	1.8	2.15	2.6	Vdc
Drain-Source On-Voltage ($V_{GS} = 10$ Vdc, $I_D = 0.78$ Adc)	$V_{DS(on)}$	—	0.11	—	Vdc
Forward Transconductance ($V_{DS} = 7.5$ Vdc, $I_D = 4.7$ Adc)	g_{fs}	—	4.4	—	S

1. Continuous use at maximum temperature will affect MTTF.
2. MTTF calculator available at <http://www.nxp.com/RF/calculators>.
3. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.nxp.com/RF> and search for AN1955.

(continued)

Table 5. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted) (continued)

Characteristic	Symbol	Min	Typ	Max	Unit
Dynamic Characteristics					
Reverse Transfer Capacitance ($V_{DS} = 7.5\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$)	C_{rss}	—	1.7	—	pF
Output Capacitance ($V_{DS} = 7.5\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$)	C_{oss}	—	39.8	—	pF
Input Capacitance ($V_{DS} = 7.5\text{ Vdc}$, $V_{GS} = 0\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz)	C_{iss}	—	68.9	—	pF

Functional Tests (In NXP Narrowband Production Test Fixture, 50 ohm system) $V_{DD} = 7.5\text{ Vdc}$, $I_{DQ} = 100\text{ mA}$, $P_{in} = 18\text{ dBm}$, $f = 520\text{ MHz}$

Common-Source Amplifier Output Power	P_{out}	—	6.8	—	W
Drain Efficiency	η_D	—	70.8	—	%

Load Mismatch/Ruggedness (In NXP Test Narrowband Production Fixture, 50 ohm system) $I_{DQ} = 100\text{ mA}$

Frequency (MHz)	Signal Type	VSWR	P_{in} (dBm)	Test Voltage, V_{DD}	Result
520	CW	> 65:1 at all Phase Angles	21 (3 dB Overdrive)	10.8	No Device Degradation

Table 6. Ordering Information

Device	Tape and Reel Information	Package
AFM906NT1	T1 Suffix = 1,000 Units, 16 mm Tape Width, 7-inch Reel	DFN 4 × 6

TYPICAL CHARACTERISTICS

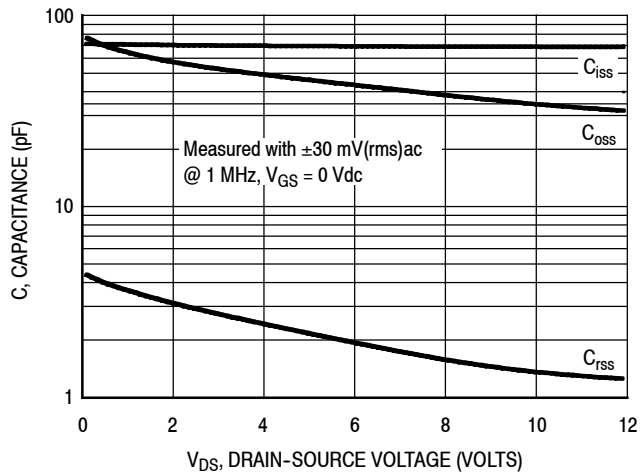
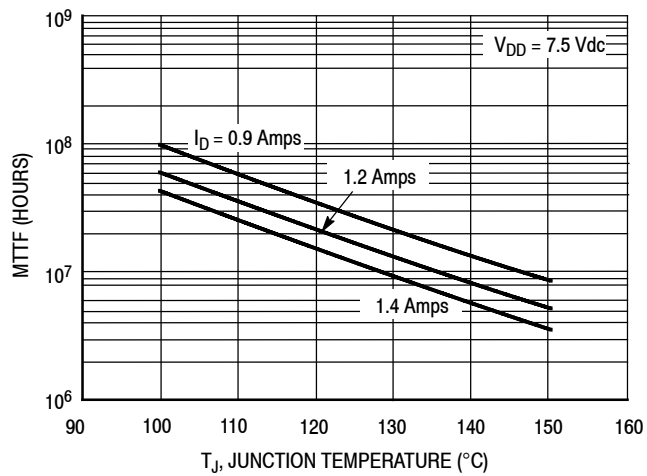


Figure 2. Capacitance versus Drain-Source Voltage



Note: MTTF value represents the total cumulative operating time under indicated test conditions.

MTTF calculator available at <http://www.nxp.com/RF/calculators>.

Figure 3. MTTF versus Junction Temperature – CW

440–520 MHz UHF BROADBAND REFERENCE CIRCUIT

Table 7. 440–520 MHz UHF Broadband Performance (In NXP UHF Broadband Reference Circuit, 50 ohm system) $V_{DD} = 7.5$ Vdc, $I_{DQ} = 150$ mA, $T_A = 25^\circ\text{C}$, CW

Frequency (MHz)	P_{in} (W)	G_{ps} (dB)	η_D (%)	P_{out} (W)
440	0.1	18.1	61.2	6.5
480	0.1	18.1	66.0	6.5
520	0.11	17.8	66.5	6.5

**440–520 MHz UHF BROADBAND REFERENCE CIRCUIT —
0.83" × 1.88" (21.1 mm × 47.8 mm)**

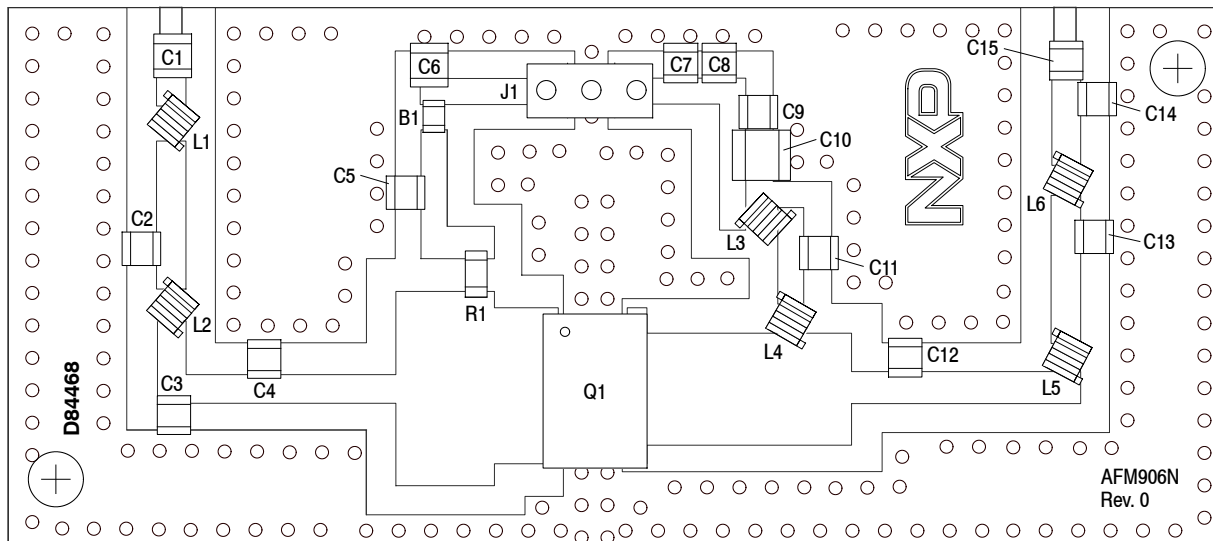


Figure 4. AFM906N UHF Broadband Reference Circuit Component Layout — 440–520 MHz

Table 8. AFM906N UHF Broadband Reference Circuit Component Designations and Values — 440–520 MHz

Part	Description	Part Number	Manufacturer
B1	30 Ω, 6 A Ferrite Bead	MPZ2012S300AT000	TDK
C1, C5, C15	100 pF Chip Capacitors	ATC600F101JT250XT	ATC
C2, C11	15 pF Chip Capacitors	ATC600F150JT250XT	ATC
C3	39 pF Chip Capacitor	ATC600F390JT250XT	ATC
C4, C12	47 pF Chip Capacitors	ATC600F470JT250XT	ATC
C6, C7	0.1 μF Chip Capacitors	GRM21BR71H104KA01B	Murata
C8	0.01 μF Chip Capacitor	GRM21BR72A103KA01B	Murata
C9	200 pF Chip Capacitor	GQM2195C2A201GB12D	Murata
C10	2.2 μF Chip Capacitor	GRM31CR71H225KA88L	Murata
C13	22 pF Chip Capacitor	ATC600F220JT250XT	ATC
C14	5.1 pF Chip Capacitor	ATC600F5R1BT250XT	ATC
J1	Right-Angle Breakaway Headers (3 Pins)	22-28-8360	Molex
L1, L2	5.5 nH Inductors	0806SQ-5N5JLC	Coilcraft
L3, L6	8.1 nH Inductors	0908SQ-8N1JLC	Coilcraft
L4	6 nH Inductor	0806SQ-6N0JLC	Coilcraft
L5	1.65 nH Inductor	0906-2JLC	Coilcraft
Q1	RF Power LDMOS Transistor	AFM906N	NXP
R1	10 Ω, 1/4 W Chip Resistor	CRCW120610R0JNEA	Vishay
PCB	0.020", ε _r = 4.8, Shengyi S1000-2	D84468	MTL

TYPICAL CHARACTERISTICS — 440–520 MHz UHF BROADBAND REFERENCE CIRCUIT

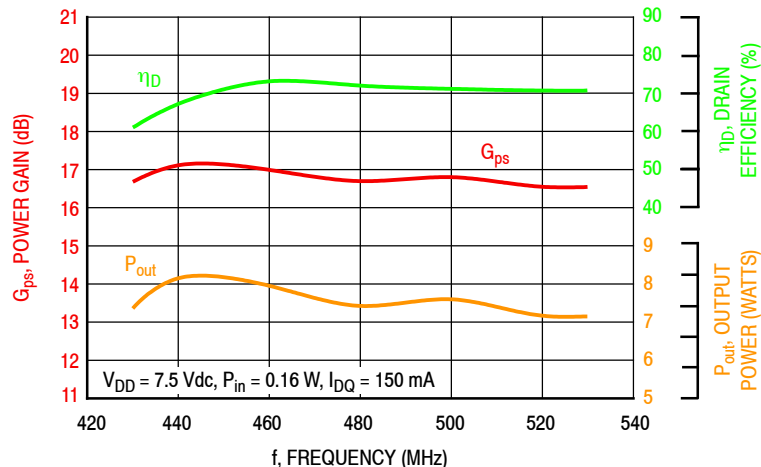


Figure 5. Power Gain, Drain Efficiency and Output Power versus Frequency at a Constant Input Power — 7.5 Vdc

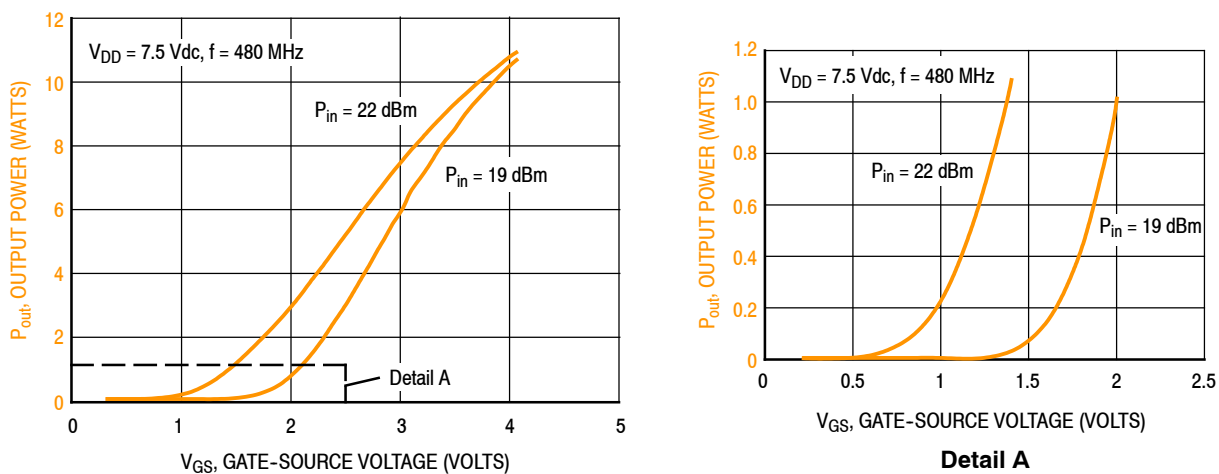


Figure 6. Output Power versus Gate-Source Voltage

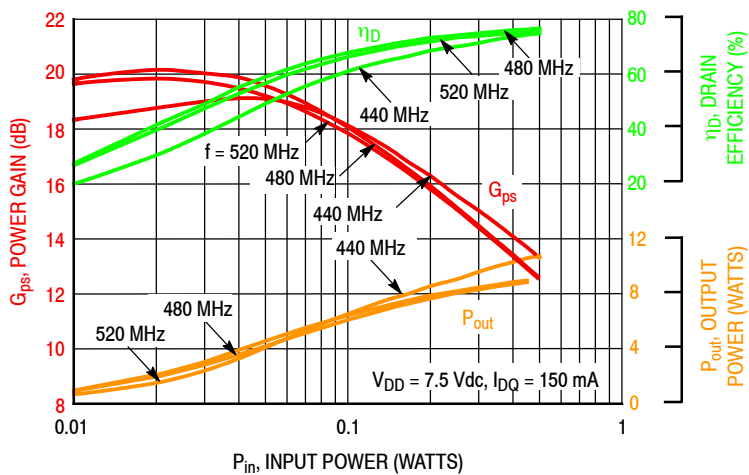
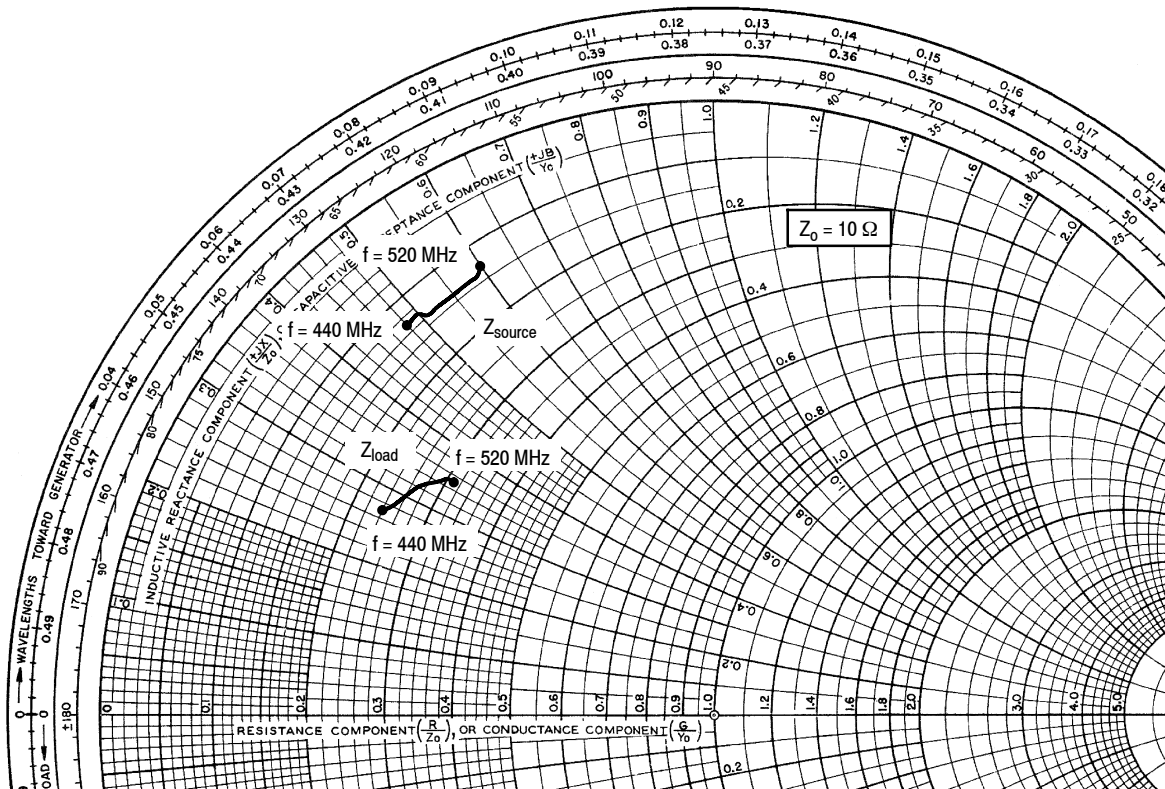


Figure 7. Power Gain, Drain Efficiency and Output Power versus Input Power and Frequency

440–520 MHz UHF BROADBAND REFERENCE CIRCUIT



f MHz	Z _{source} Ω	Z _{load} Ω
440	1.3 + j4.8	2.4 + j2.7
450	1.3 + j5.0	2.5 + j2.8
460	1.4 + j5.1	2.6 + j3.0
470	1.4 + j5.3	2.7 + j3.2
480	1.4 + j5.4	2.8 + j3.3
490	1.4 + j5.6	2.9 + j3.4
500	1.4 + j5.7	2.9 + j3.4
510	1.4 + j5.8	3.0 + j3.5
520	1.3 + j6.0	3.1 + j3.5

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

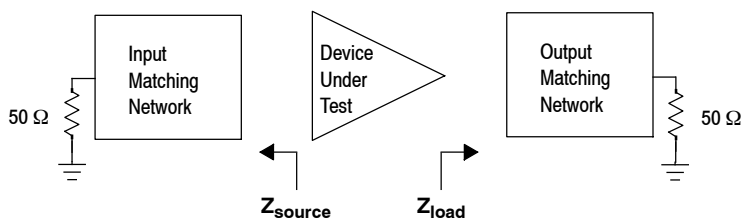


Figure 8. UHF Broadband Series Equivalent Source and Load Impedance — 440–520 MHz

520 MHz NARROWBAND PRODUCTION TEST FIXTURE — 3" × 5" (7.6 cm × 12.7 cm)

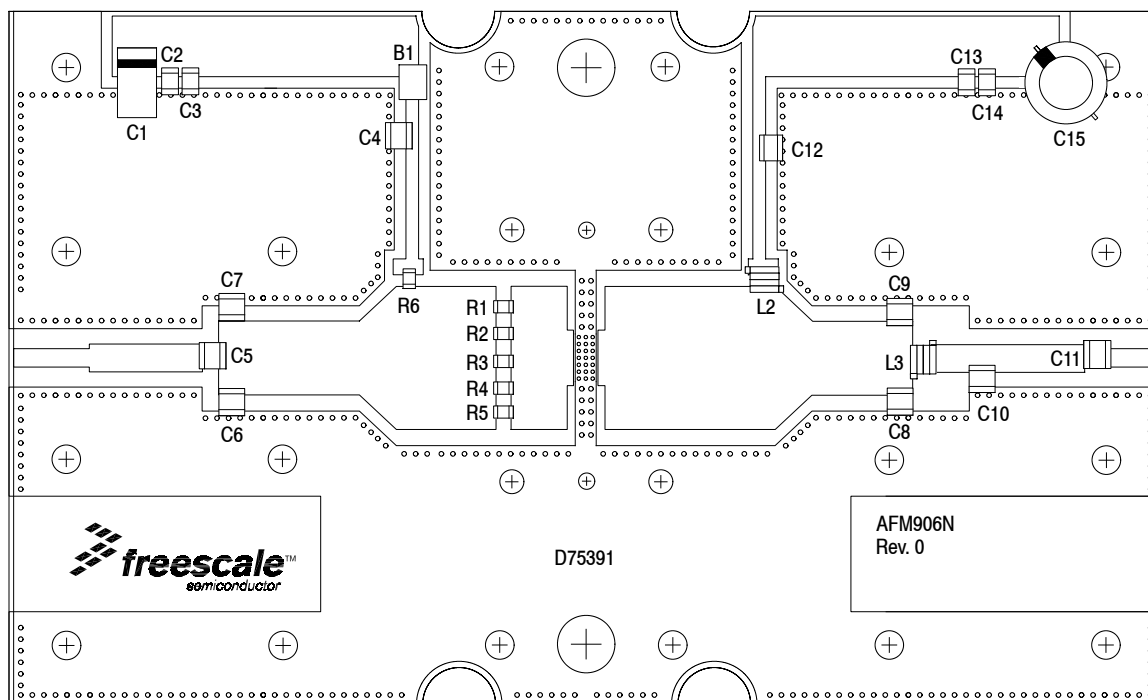


Figure 9. AFM906N Narrowband Test Circuit Component Layout — 520 MHz

Table 9. AFM906N Narrowband Test Circuit Component Designations and Values — 520 MHz

Part	Description	Part Number	Manufacturer
B1	Short RF Bead	2743019447	Fair-Rite
C1	22 μ F, 35 V Tantalum Capacitor	T491X226K035AT	Kemet
C2, C14	0.1 μ F Chip Capacitors	CDR33BX104AKWS7370	Kemet
C3, C13	0.01 μ F Chip Capacitors	C0805C103K5RACTU	Kemet
C4, C12	180 pF Chip Capacitors	ATC100B181JT300XT	ATC
C5	9.1 pF Chip Capacitor	ATC100B9R1CT500XT	ATC
C6, C11	15 pF Chip Capacitors	ATC100B150JT500XT	ATC
C7	13 pF Chip Capacitor	ATC100B130JT500XT	ATC
C8, C9	16 pF Chip Capacitors	ATC100B160JT500XT	ATC
C10	2 pF Chip Capacitor	ATC100B2R0BT500XT	ATC
C15	330 μ F, 35 V Electrolytic Capacitor	MCGPR35V337M10X16-RH	Multicomp
L2	8 nH Inductor, 3 Turns	A03TKLC	Coilcraft
L3	5 nH Inductor, 2 Turns	A02TKLC	Coilcraft
R1, R2, R3, R4, R5	1.5 Ω , 1/4 W Chip Resistors	RC1206FR-071R5L	Yageo
R6	27 Ω , 1/4 W Chip Resistor	CRCW120627R0FKEA	Vishay
PCB	Rogers RO4350B, 0.030", $\epsilon_r = 3.66$	D75391	MTL

**TYPICAL CHARACTERISTICS — 520 MHz NARROWBAND
PRODUCTION TEST FIXTURE**

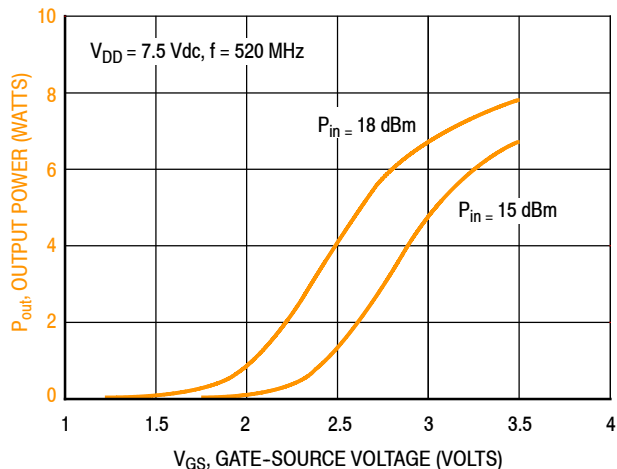


Figure 10. Output Power versus Gate-Source Voltage

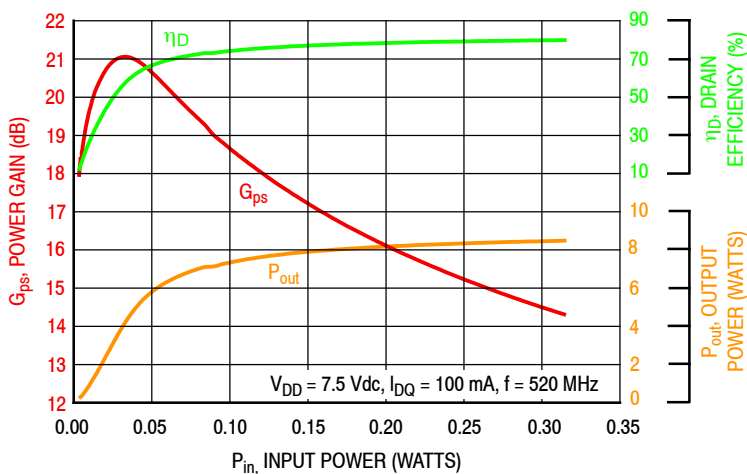


Figure 11. Power Gain, Drain Efficiency, and Output Power versus Input Power

520 MHz PRODUCTION TEST FIXTURE

f MHz	Z_{source} Ω	Z_{load} Ω
520	$1.1 + j2.5$	$1.9 + j1.5$

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

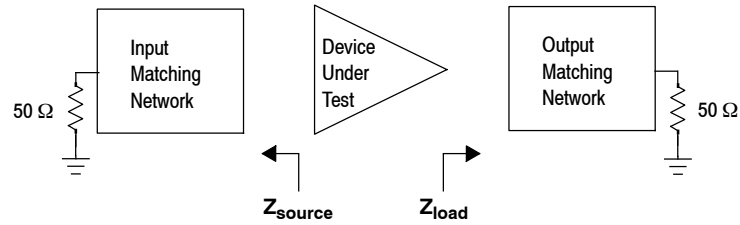


Figure 12. Series Equivalent Source and Load Impedance — 520 MHz

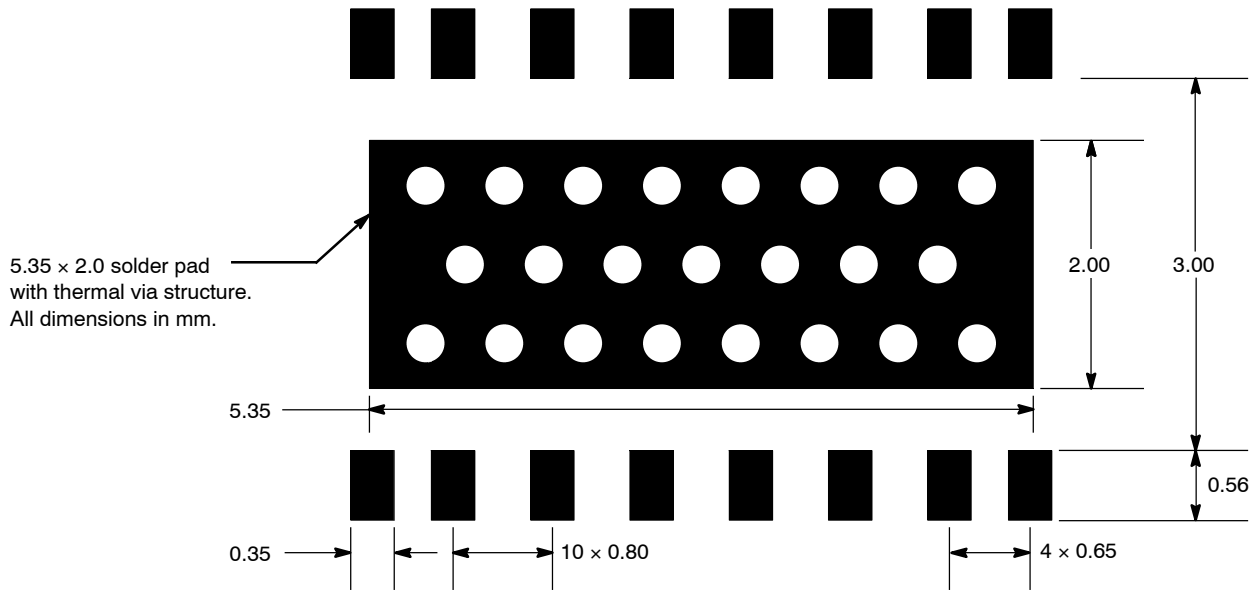
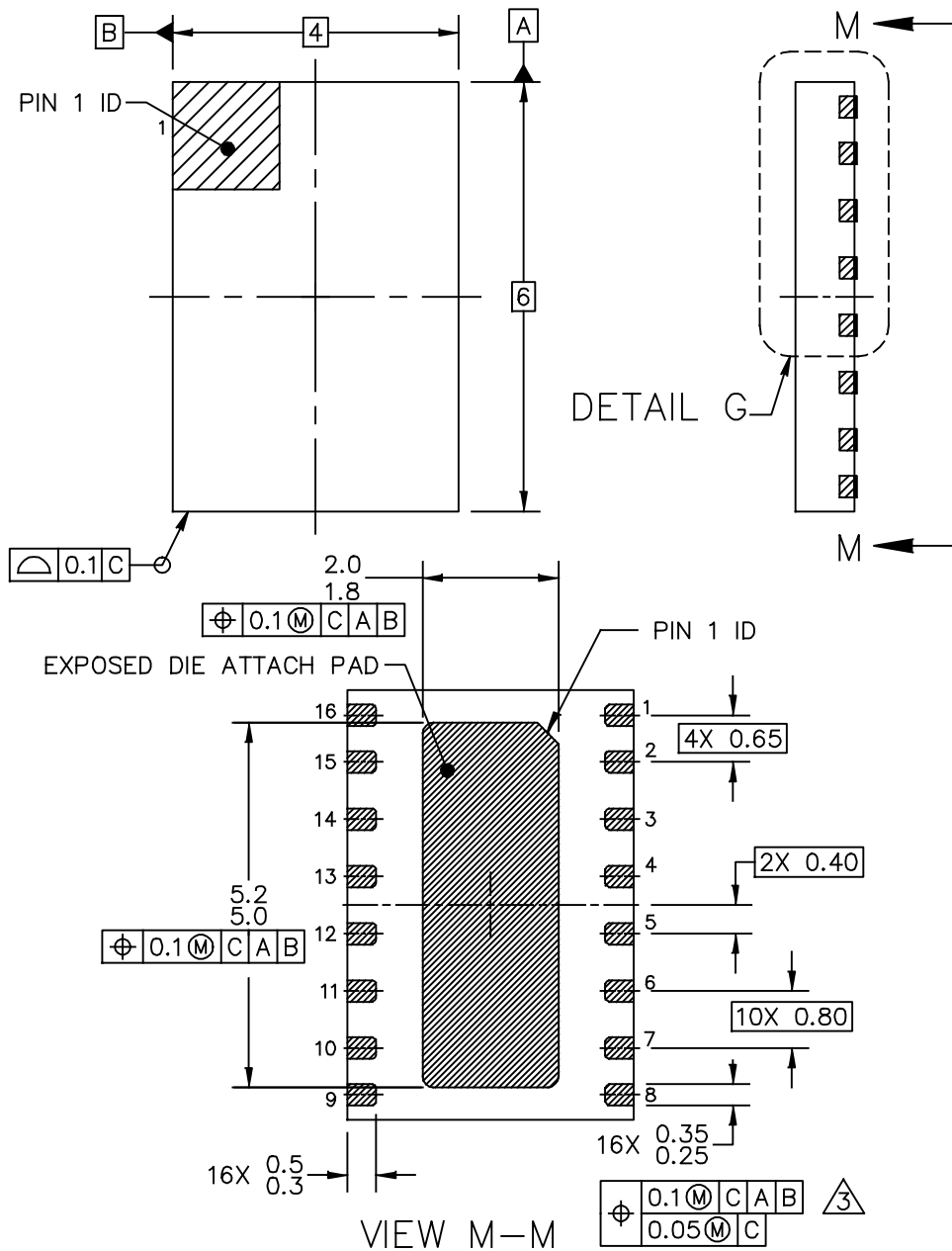


Figure 13. PCB Pad Layout for 16-Lead DFN 4 × 6

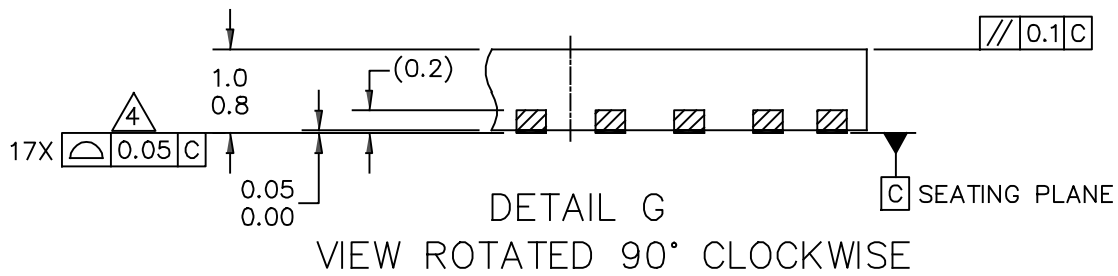


Figure 14. Product Marking

PACKAGE DIMENSIONS



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NOTES:

1. DIMENSIONING & TOLERANCING CONFIRM TO ASME Y14.5M–1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
3. THIS DIMENSION APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 MM AND 0.30 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED HEAT SLUG AS WELL AS THE TERMINALS.

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		STANDARD: NON-JEDEC	
		SOT1862-1	27 JUL 2016

PRODUCT DOCUMENTATION, SOFTWARE AND TOOLS

Refer to the following resources to aid your design process.

Application Notes

- AN1907: Solder Reflow Attach Method for High Power RF Devices in Over-Molded Plastic Packages
- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

Engineering Bulletins

- EB212: Using Data Sheet Impedances for RF LDMOS Devices

Software

- Electromigration MTTF Calculator
- RF High Power Model
- .s2p File

Development Tools

- Printed Circuit Boards

To Download Resources Specific to a Given Part Number:

1. Go to <http://www.nxp.com/RF>
2. Search by part number
3. Click part number link
4. Choose the desired resource from the drop down menu

REVISION HISTORY

The following table summarizes revisions to this document.

Revision	Date	Description
0	July 2016	<ul style="list-style-type: none">• Initial release of data sheet
1	Aug. 2016	<ul style="list-style-type: none">• 440-520 MHz UHF broadband reference circuit: added performance data and graphs, reference circuit component layout and component designations, pp. 5-8
2	Nov. 2018	<ul style="list-style-type: none">• Table 1, Max Ratings table, Operating Voltage: changed 7.5 Vdc to 12.5 Vdc to reflect additional qualification data, p. 2• Fig. 12, Series Equivalent Source and Load Impedance — 520 MHz: added to data sheet, p. 11

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